# 3-to-8 Line Decoder

The MC74VHC138 is an advanced high speed CMOS 3-to-8 decoder fabricated with silicon gate CMOS technology. It achieves high speed operation similar to equivalent Bipolar Schottky TTL while maintaining CMOS low power dissipation.

When the device is enabled, three Binary Select inputs (A0 – A2) determine which one of the outputs  $(\overline{Y0} - \overline{Y7})$  will go Low. When enable input E3 is held Low or either  $\overline{E2}$  or  $\overline{E1}$  is held High, decoding function is inhibited and all outputs go high. E3,  $\overline{E2}$ , and  $\overline{E1}$  inputs are provided to ease cascade connection and for use as an address decoder for memory systems.

The internal circuit is composed of three stages, including a buffer output which provides high noise immunity and stable output. The inputs tolerate voltages up to 7V, allowing the interface of 5V systems to 3V systems.

- High Speed:  $t_{PD} = 5.7 \text{ns}$  (Typ) at  $V_{CC} = 5 \text{ V}$
- Low Power Dissipation:  $I_{CC} = 4 \mu A$  (Max) at  $T_A = 25^{\circ}C$
- High Noise Immunity:  $V_{NIH} = V_{NIL} = 28\% V_{CC}$
- Power Down Protection Provided on Inputs
- Balanced Propagation Delays
- Designed for 2 V to 5.5 V Operating Range
- Low Noise: V<sub>OLP</sub> = 0.8 V (Max)
- Pin and Function Compatible with Other Standard Logic Families
- Latchup Performance Exceeds 300 mA
- ESD Performance: HBM > 2000 V; Machine Model > 200 V
- Chip Complexity: 122 FETs or 30.5 Equivalent Gates
- These Devices are Pb-Free and are RoHS Compliant



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### **MARKING DIAGRAMS**

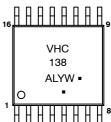


SOIC-16 **D SUFFIX CASE 751B** 



**DT SUFFIX** CASE 948F





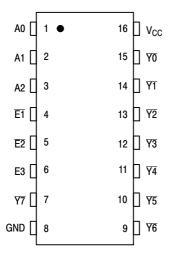
VHC138 = Specific Device Code = Assembly Location

WL, L = Wafer Lot = Year WW, W = Work Week = Pb-Free Package

#### **ORDERING INFORMATION**

| Device          | Package  | Shipping        |  |  |
|-----------------|----------|-----------------|--|--|
| MC74VHC138DG    | SOIC-16  | 48 Units/Rail   |  |  |
| MC74VHC138DR2G  | SOIC-16  | 2500 Units/Reel |  |  |
| MC74VHC138DTR2G | TSSOP-16 | 2500 Units/Reel |  |  |

### **PIN ASSIGNMENT**



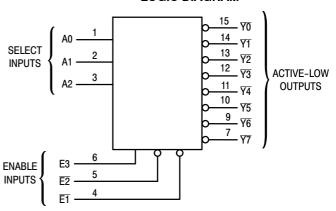
## **FUNCTION TABLE**

|    | Inputs |            |    |            |    |    |            |    | Ou         | tput       | S  |    |            |
|----|--------|------------|----|------------|----|----|------------|----|------------|------------|----|----|------------|
| E3 | E2     | <b>E</b> 1 | A2 | <b>A</b> 1 | A0 | Y0 | <b>Y</b> 1 | Y2 | <b>Y</b> 3 | <b>Y</b> 4 | Y5 | Y6 | <b>Y</b> 7 |
| Х  | Х      | Н          | Х  | Χ          | Χ  | Н  | Н          | Н  | Н          | Н          | Н  | Н  | Н          |
| X  | Н      | Χ          | X  | Х          | Χ  | Н  | Н          | Н  | Н          | Н          | Н  | Н  | Н          |
| L  | Χ      | Χ          | X  | Χ          | Χ  | Н  | Н          | Н  | Н          | Н          | Н  | Н  | Н          |
| Н  | L      | L          | L  | L          | L  | L  | Н          | Н  | Н          | Н          | Н  | Н  | Н          |
| H  | L      | L          | L  | L          | Н  | Н  | L          | Н  | Н          | Н          | Н  | Н  | Н          |
| H  | L      | L          | L  | Н          | L  | Н  | Н          | L  | Н          | Н          | Н  | Н  | Н          |
| Н  | L      | L          | L  | Н          | Н  | Н  | Н          | Н  | L          | Н          | Н  | Н  | Н          |
| Н  | L      | L          | Н  | L          | L  | Н  | Н          | Н  | Н          | L          | Н  | Н  | Н          |
| H  | L      | L          | H  | L          | Н  | Н  | Н          | Н  | Н          | Н          | L  | Н  | Н          |
| H  | L      | L          | H  | Н          | L  | Н  | Н          | Н  | Н          | Н          | Н  | L  | Н          |
| Н  | L      | L          | Н  | Н          | Н  | Н  | Н          | Н  | Н          | Н          | Н  | Н  | L          |

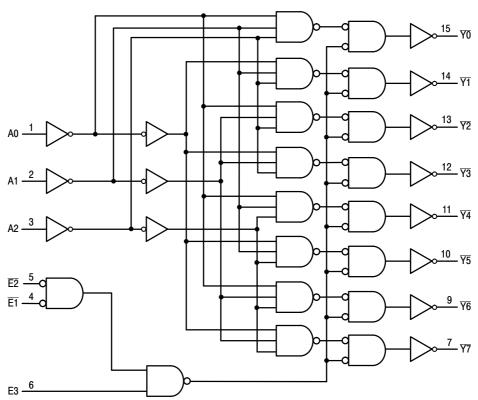
H = high level (steady state); L = low level (steady state);

X = don't care

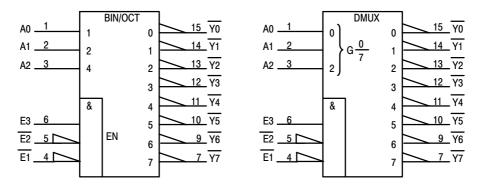
### LOGIC DIAGRAM



### **EXPANDED LOGIC DIAGRAM**



### **IEC LOGIC DIAGRAM**



#### **MAXIMUM RATINGS\***

| Symbol           | Parameter                                    |                                 | Value          | Unit |
|------------------|--|---------------------------------|----------------|------|
| V <sub>CC</sub>  | DC Supply Voltage                            |                                 | - 0.5 to + 7.0 | V    |
| V <sub>in</sub>  | DC Input Voltage                             | - 0.5 to + 7.0                  | V              |      |
| V <sub>out</sub> | DC Output Voltage                            | $-$ 0.5 to $V_{CC}$ + 0.5       | V              |      |
| I <sub>IK</sub>  | Input Diode Current                          | - 20                            | mA             |      |
| I <sub>OK</sub>  | Output Diode Current                         | ± 20                            | mA             |      |
| l <sub>out</sub> | DC Output Current, per Pin                   |                                 | ± 25           | mA   |
| Icc              | DC Supply Current, V <sub>CC</sub> and GND I | Pins                            | ± 75           | mA   |
| P <sub>D</sub>   |  | SOIC Packages†<br>SSOP Package† | 500<br>450     | mW   |
| T <sub>stg</sub> | Storage Temperature                          |                                 | - 65 to + 150  | °C   |

<sup>\*</sup> Absolute maximum continuous ratings are those values beyond which damage to the device may occur. Exposure to these conditions or conditions beyond those indicated may adversely affect device reliability. Functional operation under absolute-maximum-rated conditions is not implied.

This device contains protection circuitry to guard against damage due to high static voltages or electric fields. However, precautions must be taken to avoid applications of any voltage higher than maximum rated voltages to this high-impedance circuit. For proper operation,  $V_{in}$  and  $V_{out}$  should be constrained to the range GND  $\leq$  ( $V_{in}$  or  $V_{out}$ )  $\leq$   $V_{CC}$ .

Unused inputs must always be tied to an appropriate logic voltage level (e.g., either GND or  $V_{CC}$ ). Unused outputs must be left open.

#### RECOMMENDED OPERATING CONDITIONS

| Symbol                          | Parameter             |                          | Min  | Max       | Unit |
|---------------------------------|-----------------------|--------------------------|------|-----------|------|
| V <sub>CC</sub>                 | DC Supply Voltage     |                          | 2.0  | 5.5       | V    |
| V <sub>in</sub>                 | DC Input Voltage      |                          | 0    | 5.5       | V    |
| V <sub>out</sub>                | DC Output Voltage     |                          | 0    | $V_{CC}$  | V    |
| T <sub>A</sub>                  | Operating Temperature |                          | - 55 | + 125     | °C   |
| t <sub>r</sub> , t <sub>f</sub> |                       | 3.3V ±0.3V<br>5.0V ±0.5V | 0    | 100<br>20 | ns/V |

The  $\theta_{JA}$  of the package is equal to 1/Derating. Higher junction temperatures may affect the expected lifetime of the device per the table and figure below.

# DEVICE JUNCTION TEMPERATURE VERSUS TIME TO 0.1% BOND FAILURES

| Junction<br>Temperature °C | Time, Hours | Time, Years |
|----------------------------|-------------|-------------|
| 80                         | 1,032,200   | 117.8       |
| 90                         | 419,300     | 47.9        |
| 100                        | 178,700     | 20.4        |
| 110                        | 79,600      | 9.4         |
| 120                        | 37,000      | 4.2         |
| 130                        | 17,800      | 2.0         |
| 140                        | 8,900       | 1.0         |

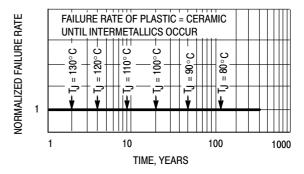


Figure 1. Failure Rate vs. Time Junction Temperature

<sup>†</sup>Derating — SOIC Packages: – 7 mW/°C from 65° to 125°C TSSOP Package: – 6.1 mW/°C from 65° to 125°C

#### DC ELECTRICAL CHARACTERISTICS

|                 |  |  | V <sub>CC</sub>          |                            | T <sub>A</sub> = 25°C | ;                          | <b>T</b> <sub>A</sub> = ≤  | 85°C                       | <b>T</b> <sub>A</sub> = ≤ 125°C |                            |      |
|-----------------|--|--|--------------------------|----------------------------|-----------------------|----------------------------|----------------------------|----------------------------|---------------------------------|----------------------------|------|
| Symbol          | Parameter  | Test Conditions  | (V)                      | Min                        | Тур                   | Max                        | Min                        | Max                        | Min                             | Max                        | Unit |
| V <sub>IH</sub> | Minimum High-Level<br>Input Voltage  |  | 2.0<br>3.0<br>4.5<br>5.5 | 1.5<br>2.1<br>3.15<br>3.85 |                       |                            | 1.5<br>2.1<br>3.15<br>3.85 |                            | 1.5<br>2.1<br>3.15<br>3.85      |                            | V    |
| V <sub>IL</sub> | Maximum<br>Low-Level Input<br>Voltage  |  | 2.0<br>3.0<br>4.5<br>5.5 |                            |                       | 0.5<br>0.9<br>1.35<br>1.65 |                            | 0.5<br>0.9<br>1.35<br>1.65 |                                 | 0.5<br>0.9<br>1.35<br>1.65 | V    |
| V <sub>OH</sub> | Minimum High-Level<br>Output Voltage<br>V <sub>IN</sub> = V <sub>IH</sub> or V <sub>IL</sub> | $V_{IN} = V_{IH} \text{ or } V_{IL}$ $I_{OH} = -50  \mu\text{A}$                       | 2.0<br>3.0<br>4.5        | 1.9<br>2.9<br>4.4          | 2.0<br>3.0<br>4.5     |                            | 1.9<br>2.9<br>4.4          |                            | 1.9<br>2.9<br>4.4               |                            | V    |
|                 |  | $V_{IN} = V_{IH} \text{ or } V_{IL}$ $I_{OH} = -4 \text{ mA}$ $I_{OH} = -8 \text{ mA}$ | 3.0<br>4.5               | 2.58<br>3.94               |                       |                            | 2.48<br>3.80               |                            | 2.34<br>3.66                    |                            |      |
| V <sub>OL</sub> | Maximum<br>Low-Level Output<br>Voltage   | $V_{IN} = V_{IH} \text{ or } V_{IL}$ $I_{OL} = 50  \mu\text{A}$                        | 2.0<br>3.0<br>4.5        |                            | 0.0<br>0.0<br>0.0     | 0.1<br>0.1<br>0.1          |                            | 0.1<br>0.1<br>0.1          |                                 | 0.1<br>0.1<br>0.1          | V    |
|                 | $V_{IN} = V_{IH}$ or $V_{IL}$  | $V_{IN} = V_{IH}$ or $V_{IL}$<br>$I_{OL} = 4$ mA<br>$I_{OL} = 8$ mA                    | 3.0<br>4.5               |                            |                       | 0.36<br>0.36               |                            | 0.44<br>0.44               |                                 | 0.52<br>0.52               |      |
| I <sub>IN</sub> | Maximum Input<br>Leakage Current   | V <sub>IN</sub> = 5.5 V or<br>GND  | 0 to<br>5.5              |                            |                       | ± 0.1                      |                            | ± 1.0                      |                                 | ± 1.0                      | μА   |
| I <sub>CC</sub> | Maximum Quiescent<br>Supply Current  | V <sub>IN</sub> = V <sub>CC</sub> or GND   | 5.5                      |                            |                       | 4.0                        |                            | 40.0                       |                                 | 40.0                       | μА   |

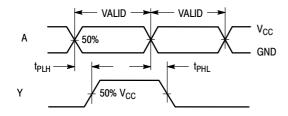
### AC ELECTRICAL CHARACTERISTICS (Input $t_r = t_f = 3.0 \text{ns}$ )

| Symbo                                  |  |                          |                              |     |             | T <sub>A</sub> = 25°C |            |              | T <sub>A</sub> = - 55 to<br>125°C |              |      |
|--|--|--------------------------|------------------------------|-----|-------------|-----------------------|------------|--------------|-----------------------------------|--------------|------|
| ı                                      | Parameter                                | Test Condi               | tions                        | Min | Тур         | Max                   | Min        | Max          | Min                               | Max          | Unit |
| t <sub>PLH</sub> ,<br>t <sub>PHL</sub> | Maximum Propagation Delay,               | $V_{CC} = 3.3 \pm 0.3 V$ | $C_L = 15pF$<br>$C_L = 50pF$ |     | 8.2<br>10.0 | 11.4<br>15.8          | 1.0<br>1.0 | 13.5<br>18.0 | 1.0<br>1.0                        | 13.5<br>18.0 | ns   |
|  | A to Y                                   | $V_{CC} = 5.0 \pm 0.5 V$ | $C_L = 15pF$<br>$C_L = 50pF$ |     | 5.7<br>7.2  | 8.1<br>10.1           | 1.0<br>1.0 | 9.5<br>11.5  | 1.0<br>1.0                        | 9.5<br>11.5  |      |
| t <sub>PLH</sub> ,<br>t <sub>PHL</sub> | Maximum Propagation Delay, E3 to Y       | $V_{CC} = 3.3 \pm 0.3 V$ | $C_L = 15pF$<br>$C_L = 50pF$ |     | 8.1<br>10.6 | 12.8<br>16.3          | 1.0<br>1.0 | 15.0<br>18.5 | 1.0<br>1.0                        | 15.0<br>18.5 | ns   |
|  | E3 10 Y                                  | $V_{CC} = 5.0 \pm 0.5 V$ | $C_L = 15pF$<br>$C_L = 50pF$ |     | 5.6<br>7.1  | 8.1<br>10.1           | 1.0<br>1.0 | 9.5<br>11.5  | 1.0<br>1.0                        | 9.5<br>11.5  |      |
| t <sub>PLH</sub> ,<br>t <sub>PHL</sub> | Maximum Propagation Delay, E2 or E1 to Y | $V_{CC} = 3.3 \pm 0.3 V$ | $C_L = 15pF$<br>$C_L = 50pF$ |     | 8.2<br>10.7 | 11.4<br>14.9          | 1.0<br>1.0 | 13.5<br>17.0 | 1.0<br>1.0                        | 13.5<br>17.0 | ns   |
|  | E2 OF E1 to Y                            | $V_{CC} = 5.0 \pm 0.5 V$ | $C_L = 15pF$<br>$C_L = 50pF$ |     | 5.8<br>7.3  | 8.1<br>10.1           | 1.0<br>1.0 | 9.5<br>11.5  | 1.0<br>1.0                        | 9.5<br>11.5  |      |
| C <sub>IN</sub>                        | Maximum Input<br>Capacitance             |                          |                              |     | 4           | 10                    |            | 10           |                                   | 10           | pF   |

|          |  | Typical @ 25°C, V <sub>CC</sub> = 5.0V |    |
|----------|--|--|----|
| $C_{PD}$ | Power Dissipation Capacitance (Note 1) | 34                                     | pF |

<sup>1.</sup> C<sub>PD</sub> is defined as the value of the internal equivalent capacitance which is calculated from the operating current consumption without load. Average operating current can be obtained by the equation: I<sub>CC(OPR)</sub> = C<sub>PD</sub> • V<sub>CC</sub> • f<sub>in</sub> + I<sub>CC</sub>. C<sub>PD</sub> is used to determine the no–load dynamic power consumption; P<sub>D</sub> = C<sub>PD</sub> • V<sub>CC</sub><sup>2</sup> • f<sub>in</sub> + I<sub>CC</sub> • V<sub>CC</sub>.

### **SWITCHING WAVEFORMS**



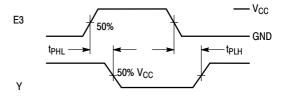


Figure 2.

Figure 3.

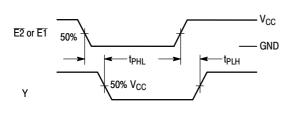
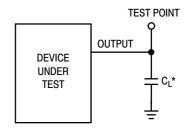


Figure 4.



\*Includes all probe and jig capacitance

Figure 5. Test Circuit

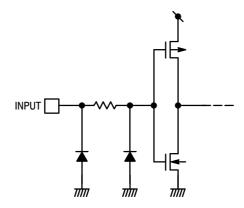
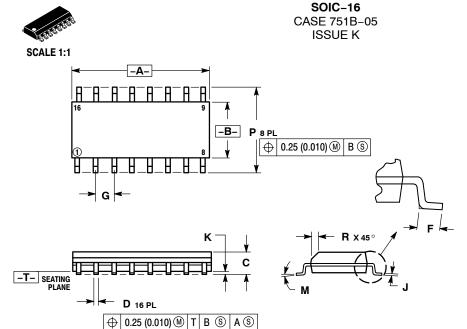


Figure 6. Input Equivalent Circuit

# **MECHANICAL CASE OUTLINE**



**DATE 29 DEC 2006** 

- NOTES:
  1. DIMENSIONING AND TOLERANCING PER ANSI
- THE NOTION AND TOLETANOING FER ANSI'Y 14.5M, 1982.
  CONTROLLING DIMENSION: MILLIMETER.
  DIMENSIONS A AND B DO NOT INCLUDE MOLD PROTRUSION.
- PHOI HUSION.

  MAXIMUM MOLD PROTRUSION 0.15 (0.006) PER SIDE.

  DIMENSION D DOES NOT INCLUDE DAMBAR
  PROTRUSION. ALLOWABLE DAMBAR PROTRUSION

  SHALL BE 0.127 (0.005) TOTAL IN EXCESS OF THE D

  DIMENSION AT MAXIMUM MATERIAL CONDITION.

|     | MILLIN | METERS | INCHES    |       |  |
|-----|--------|--------|-----------|-------|--|
| DIM | MIN    | MAX    | MIN       | MAX   |  |
| Α   | 9.80   | 10.00  | 0.386     | 0.393 |  |
| В   | 3.80   | 4.00   | 0.150     | 0.157 |  |
| C   | 1.35   | 1.75   | 0.054     | 0.068 |  |
| D   | 0.35   | 0.49   | 0.014     | 0.019 |  |
| F   | 0.40   | 1.25   | 0.016     | 0.049 |  |
| G   | 1.27   | BSC    | 0.050 BSC |       |  |
| J   | 0.19   | 0.25   | 0.008     | 0.009 |  |
| K   | 0.10   | 0.25   | 0.004     | 0.009 |  |
| M   | 0°     | 7°     | 0°        | 7°    |  |
| Р   | 5.80   | 6.20   | 0.229     | 0.244 |  |
| R   | 0.25   | 0.50   | 0.010     | 0.019 |  |

| STYLE 1: |               | STYLE 2: |               | STYLE 3: |                     | STYLE 4: |                |   |   |
|----------|---------------|----------|---------------|----------|---------------------|----------|----------------|---|---|
| PIN 1.   | COLLECTOR     | PIN 1.   | CATHODE       | PIN 1.   | COLLECTOR, DYE #1   | PIN 1.   | COLLECTOR, DYE | #1  |   |
| 2.       | BASE          | 2.       | ANODE         | 2.       | BASE, #1            | 2.       | COLLECTOR, #1  |   |   |
| 3.       | EMITTER       | 3.       | NO CONNECTION | 3.       | EMITTER, #1         | 3.       | COLLECTOR, #2  |   |   |
| 4.       | NO CONNECTION | 4.       | CATHODE       | 4.       | COLLECTOR, #1       | 4.       | COLLECTOR, #2  |   |   |
| 5.       | EMITTER       | 5.       | CATHODE       | 5.       | COLLECTOR, #2       | 5.       | COLLECTOR, #3  |   |   |
| 6.       | BASE          | 6.       | NO CONNECTION |          | BASE, #2            | 6.       | COLLECTOR, #3  |   |   |
| 7.       | COLLECTOR     | 7.       | ANODE         | 7.       |                     | 7.       | COLLECTOR, #4  |   |   |
| 8.       | COLLECTOR     | 8.       | CATHODE       | 8.       | COLLECTOR, #2       | 8.       | COLLECTOR, #4  |   |   |
| 9.       | BASE          | 9.       | CATHODE       | 9.       | COLLECTOR, #3       | 9.       | BASE, #4       |   |   |
| 10.      | EMITTER       | 10.      | ANODE         | 10.      | BASE, #3            | 10.      | EMITTER, #4    |   |   |
| 11.      | NO CONNECTION | 11.      | NO CONNECTION | 11.      | EMITTER, #3         | 11.      | BASE, #3       |   |   |
| 12.      | EMITTER       | 12.      | CATHODE       | 12.      | COLLECTOR, #3       | 12.      | EMITTER, #3    |   |   |
| 13.      | BASE          | 13.      | CATHODE       | 13.      | COLLECTOR, #4       | 13.      | BASE, #2       | OOL DEDING                                    | COOTDONT                                |
| 14.      | COLLECTOR     | 14.      | NO CONNECTION | 14.      | BASE, #4            | 14.      | EMITTER, #2    | SOLDERING                                     | FOOTPRINT                               |
| 15.      | EMITTER       | 15.      | ANODE         | 15.      | EMITTER, #4         | 15.      | BASE, #1       |   | 8X                                      |
| 16.      | COLLECTOR     | 16.      | CATHODE       | 16.      | COLLECTOR, #4       | 16.      | EMITTER, #1    |   | i.40 — →                                |
|          |               |          |               |          |                     |          |                | - 0   | .40                                     |
| STYLE 5: |               | STYLE 6: |               | STYLE 7: |                     |          |                |   | 16X 1.12                                |
| PIN 1.   | DRAIN, DYE #1 |          | CATHODE       | PIN 1.   | SOURCE N-CH         |          |                |   | 10% 1.12                                |
| 2.       | DRAIN, #1     |          | CATHODE       | 2.       | COMMON DRAIN (OUTPU | Τ\       |                | 1   | 16                                      |
| 3.       | DRAIN, #2     | 3.       |               | 3.       | COMMON DRAIN (OUTPU |          |                | <b>, L</b> .                                  | '0                                      |
| 3.<br>4. | DRAIN, #2     | 3.<br>4. | CATHODE       | 3.<br>4. | GATE P-CH           | 1)       |                | <del>-</del> —                                |   |
| 4.<br>5. | DRAIN, #2     | 4.<br>5. | CATHODE       | 4.<br>5. | COMMON DRAIN (OUTPU | Τ\       |                | , <b>, , , , , , , , , , , , , , , , , , </b> |   |
| 5.<br>6. | DRAIN, #3     | 6.       | CATHODE       | 6.       | COMMON DRAIN (OUTPU |          | 16             | 5X 1 -  |   |
| 7.       | DRAIN, #4     | 7.       | CATHODE       | 7.       | COMMON DRAIN (OUTPU |          | 0.5            | 58  | , L                                     |
| 8.       | DRAIN, #4     | 8.       | CATHODE       | 8.       | SOURCE P-CH         | •,       |                |   |   |
| 9.       | GATE, #4      | 9.       | ANODE         | 9.       | SOURCE P-CH         |          |                |   |   |
| 10.      | SOURCE, #4    | 10.      | ANODE         | 10.      | COMMON DRAIN (OUTPU | T)       |                |   |   |
| 11.      | GATE, #3      | 11.      |               | 11.      | COMMON DRAIN (OUTPU |          |                |   |   |
| 12.      | SOURCE, #3    | 12.      |               | 12.      | COMMON DRAIN (OUTPU |          |                |   |   |
| 13.      | GATE, #2      | 13.      |               | 13.      | GATE N-CH           | .,       |                |   |   |
| 14.      | SOURCE, #2    | 14.      |               | 14.      | COMMON DRAIN (OUTPU | T)       |                | <del></del>                                   | V PITCH                                 |
| 15.      | GATE, #1      | 15.      | ANODE         | 15.      | COMMON DRAIN (OUTPU |          |                |   | 1 <u>+=</u> 1- <b>1</b>                 |
| 16.      | SOURCE, #1    |          | ANODE         | 16.      | SOURCE N-CH         | .,       |                |   |   |
|          |               |          |               |          |                     |          |                | <b>□</b> 8                                    | 9 + - + -                               |
|          |               |          |               |          |                     |          |                |   | ~ <b></b>                               |
|          |               |          |               |          |                     |          |                |   | ' |
|          |               |          |               |          |                     |          |                |   | DIMENSIONS: MILLIMETERS                 |

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| DESCRIPTION:     | SOIC-16     |   | PAGE 1 OF 1 |  |  |  |

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☐ 0.10 (0.004)

D

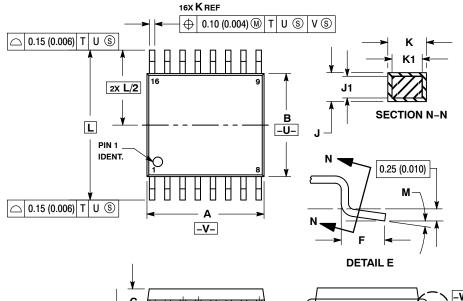
-T- SEATING PLANE





TSSOP-16 CASE 948F-01 ISSUE B

**DATE 19 OCT 2006** 



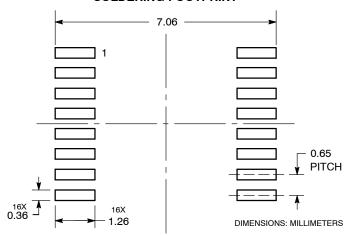
#### NOTES

- JIES:
  DIMENSIONING AND TOLERANCING PER
  ANSI Y14.5M, 1982.
  CONTROLLING DIMENSION: MILLIMETER.
  DIMENSION A DOES NOT INCLUDE MOLD
  FLASH. PROTRUSIONS OR GATE BURRS.
  MOLD EL ROLL OF GATE BURDS SUAL NO.
- MOLD FLASH OR GATE BURRS SHALL NOT EXCEED 0.15 (0.006) PER SIDE.
  DIMENSION B DOES NOT INCLUDE INTERLEAD FLASH OR PROTRUSION.
  INTERLEAD FLASH OR PROTRUSION SHALL NOT EXCEED 0.25 (0.010) PER SIDE.
- DIMENSION K DOES NOT INCLUDE DAMBAR PROTRUSION. ALLOWABLE DAMBAR PROTRUSION SHALL BE 0.08 (0.003) TOTAL IN EXCESS OF THE K DIMENSION AT MAXIMUM MATERIAL CONDITION. TERMINAL NUMBERS ARE SHOWN FOR
- REFERENCE ONLY.
- DIMENSION A AND B ARE TO BE DETERMINED AT DATUM PLANE -W-.

|     | MILLIN   | IETERS | INCHES    |       |  |  |
|-----|----------|--------|-----------|-------|--|--|
| DIM | MIN      | MAX    | MIN       | MAX   |  |  |
| Α   | 4.90     | 5.10   | 0.193     | 0.200 |  |  |
| В   | 4.30     | 4.50   | 0.169     | 0.177 |  |  |
| C   |          | 1.20   |           | 0.047 |  |  |
| D   | 0.05     | 0.15   | 0.002     | 0.006 |  |  |
| F   | 0.50     | 0.75   | 0.020     | 0.030 |  |  |
| G   | 0.65     | BSC    | 0.026 BSC |       |  |  |
| Н   | 0.18     | 0.28   | 0.007     | 0.011 |  |  |
| 7   | 0.09     | 0.20   | 0.004     | 0.008 |  |  |
| J1  | 0.09     | 0.16   | 0.004     | 0.006 |  |  |
| K   | 0.19     | 0.30   | 0.007     | 0.012 |  |  |
| K1  | 0.19     | 0.25   | 0.007     | 0.010 |  |  |
| L   | 6.40 BSC |        | 0.252 BSC |       |  |  |
| М   | ٥°       | QΟ     | ٥°        | gο    |  |  |

### **SOLDERING FOOTPRINT**

G



#### **GENERIC MARKING DIAGRAM\***



XXXX = Specific Device Code Α = Assembly Location

= Wafer Lot L Υ = Year W = Work Week = Pb-Free Package

\*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot " ■", may or may not be present.

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|------------------|-------------|---|-------------|
| DESCRIPTION:     | TSSOP-16    |   | PAGE 1 OF 1 |

**DETAIL E** 

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